

Editorial

Statement of Peer Review †

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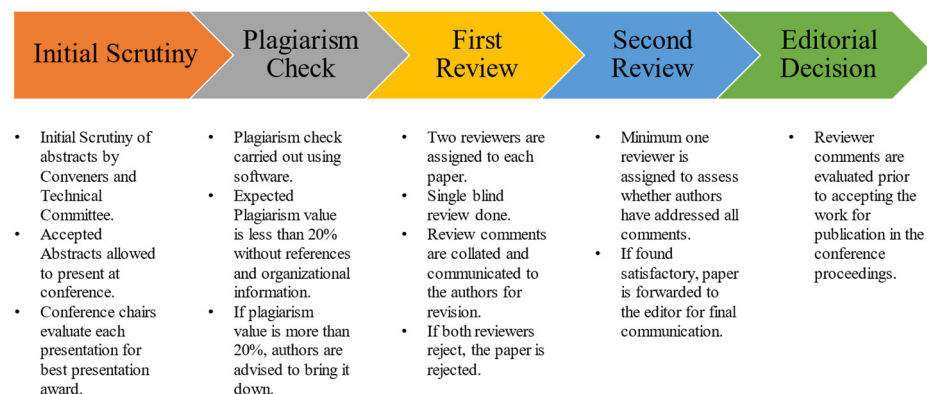
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In submitting conference proceedings to *Engineering Proceedings*, the volume editors of the proceedings certify to the publisher that all papers published in this volume have been subjected to peer review administered by the volume editors. Reviews were conducted by expert referees to the professional and scientific standards expected of a proceedings journal.

- Type of peer review: single-blind.
- Conference submission management system: Through Email and Google Forms.
- Total number of abstracts received: 252.
- Total number of abstracts shortlisted: 205.
- Number of submissions assigned to Engineering Proceedings: 111.
- Number of submissions sent for review: 62.
- Number of submissions accepted: 48.
- Acceptance rate (number of submissions accepted/number of submissions received): 77%.
- Average number of reviews per paper: 2 (First Review) + 1 (Second Review)
- Total number of reviewers involved: 22.
- Peer review criteria and process: Figure 1.



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Figure 1. Peer review criteria and process.

Conflicts of Interest: The authors declare no conflict of interest.

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